

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Zongjin LI</td> <td>12/21/2011</td> </tr> <tr> <td>Shengwen TANG</td> <td>12/21/2011</td> </tr> <tr> <td>Youyuan LU</td> <td>12/21/2011</td> </tr> </tbody> </table>		Name	Execution Date	Zongjin LI	12/21/2011	Shengwen TANG	12/21/2011	Youyuan LU	12/21/2011
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Zongjin LI	12/21/2011								
Shengwen TANG	12/21/2011								
Youyuan LU	12/21/2011								
RECEIVING PARTY DATA									
Name:	THE HONG KONG UNIVERSITY OF SCIENCE AND TECHNOLOGY								
Street Address:	Clear Water Bay, Kowloon								
City:	Hong Kong								
State/Country:	CHINA								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13333124</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13333124				
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Application Number:	13333124								
CORRESPONDENCE DATA									
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Total Attachments: 2 source=ExeAssignment_TTC.PA.0488_FINAL_20111221#page1.tif source=ExeAssignment_TTC.PA.0488_FINAL_20111221#page2.tif									

OP \$40.00 13333124

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION given to **Zongjin LI, Shengwen TANG** and **Youyuan LU** hereinafter referred to as the ASSIGNOR(S), who has/have invented certain new and useful **PORE STRUCTURE ANALYZER BASE ON NON-CONTACT IMPEDANCE MEASUREMENT FOR CEMENT-BASED MATERIALS**, hereinafter referred to as the invention, for which I/we has/have executed an application for Letters Patent to be filed in the United States Patent and Trademark Office.


WHEREAS, **The Hong Kong University of Science and Technology**, a corporation organized and existing under the laws of the country/state of **Hong Kong**, whose post office address/business address is **Clear Water Bay, Kowloon, Hong Kong, China**, hereinafter referred to as the ASSIGNEE, desires to acquire the entire right, title and interest for the United States and elsewhere throughout the world in and to said invention and application, including any and all divisions and continuations thereof, all rights of priority under the terms of the International Convention for the Protection of Industrial Property, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof.

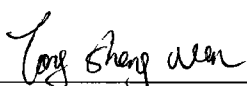
NOW, WITNESSETH THIS that for good and valuable consideration, the receipt, adequacy and sufficiency of which are hereby acknowledged, said ASSIGNOR(S) hereby assign(s), sell(s) and transfer(s) to said ASSIGNEE, its assigns and legal representatives, the entire right, title and interest for the United States and elsewhere throughout the world, in and to said invention and application, including any and all divisions and continuations thereof, all rights of priority under the terms of the International Convention for the Protection of Industrial Property, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any way arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said ASSIGNEE and its assigns and legal representatives, in as ample and as beneficial a manner for all intents and purposes as said ASSIGNOR(S) might or could have held and enjoyed the same had this assignment not been made.

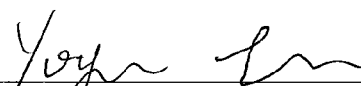
ASSIGNMENT

ALSO, said ASSIGNOR(S) hereby agree(s) to execute all papers necessary to file said applications in the United States and elsewhere throughout the world, and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing any and all Letters Patent thereon.

AND said ASSIGNOR(S) authorize(s) and request(s) the Commissioner of Patents to issue a Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

By:  21 Dec 2011
Inventor's Name: **Zongjin LI** Date
(first or first inventor)

By:  21 Dec 2011
Inventor's Name: **Shengwen TANG** Date
(second inventor)

By:  21 Dec 2011
Inventor's Name: **Youyuan LU** Date
(third inventor)

By: _____
Inventor's Name: _____ Date
(fourth inventor)